

Features

- The plastic package carries UL Flammability Classification 94V-0
- For surface mounted applications
- Low power loss, high efficiency
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed:260°C/10 seconds at terminals



Mechanical Characteristics

- Case: SMC(DO-214AB) package molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.0088 ounce, 0.25 grams

Absolute Maximum Ratings and Electrical Parameters (TA=25°C unless otherwise specified)

PARAMETER	SYMBOL	SS52	SS53	SS54	SS55	SS56	SS58	SS510	SS515	SS520	UNIT	
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	80	100	150	200	V	
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	56	70	105	140	V	
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	80	100	150	200	V	
Maximum average forward rectified current	I_{AV}	5									A	
Peak forward surge current ^(NOTE1)	I_{FSM}	100									A	
Maximum instantaneous forward voltage at 5A	V_F	0.55			0.7		0.85		0.9		V	
Maximum DC reverse current at rated DC blocking voltage	$T_A=25\text{ }^\circ\text{C}$	I_R					100		50		μA	
	$T_A=100\text{ }^\circ\text{C}$	I_{RT}					5000		2000		μA	
Typical junction capacitance ^(NOTE 2)	C_J	550				450				pF		
Typical Thermal Resistance Junction to Ambient ^(NOTE3)	$R_{\theta JA}$	55									$^\circ\text{C/W}$	
Typical Thermal Resistance Junction to Lead ^(NOTE3)	$R_{\theta JL}$	15									$^\circ\text{C/W}$	
Operating Temperature Range	T_J	-55 to 125					-55 to 150					$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to 150									$^\circ\text{C}$	

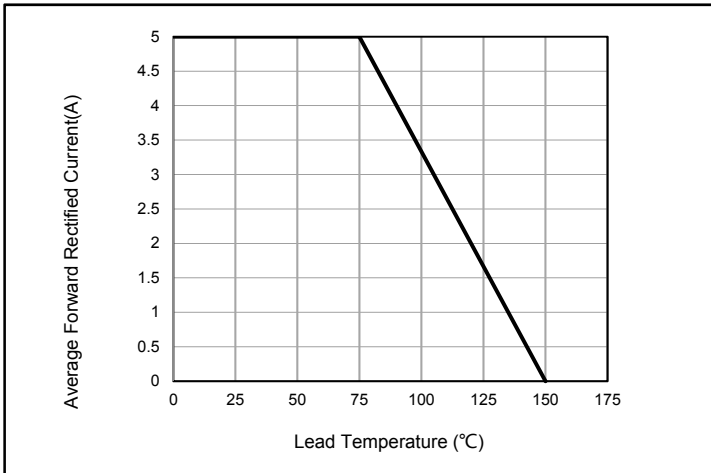
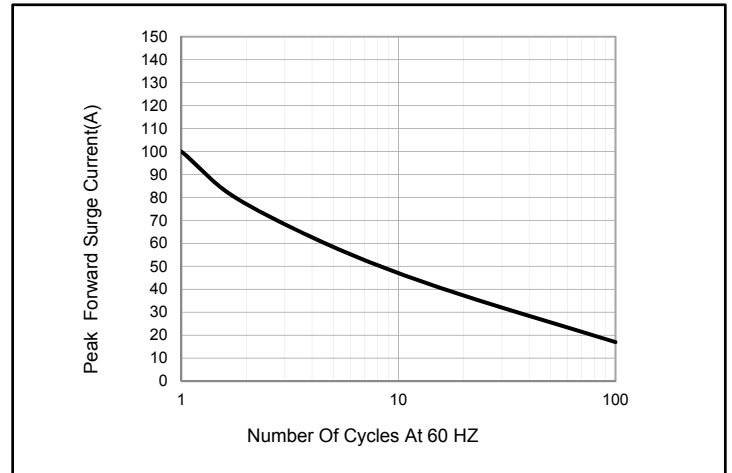
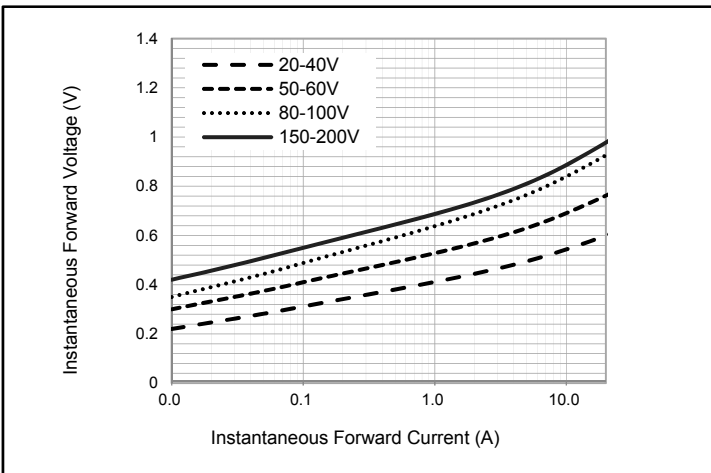
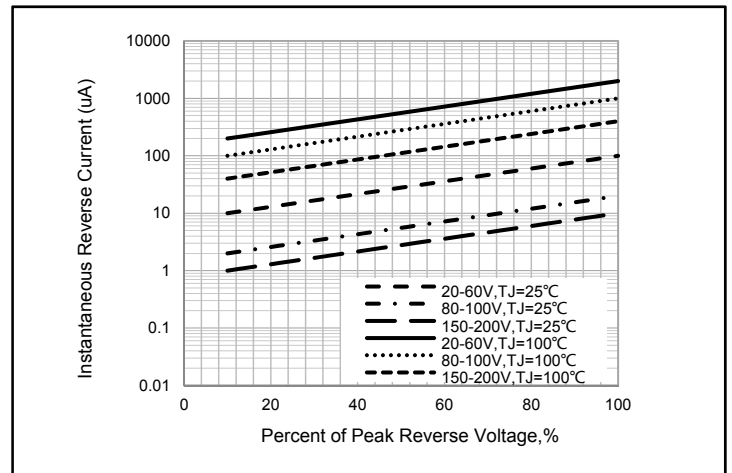
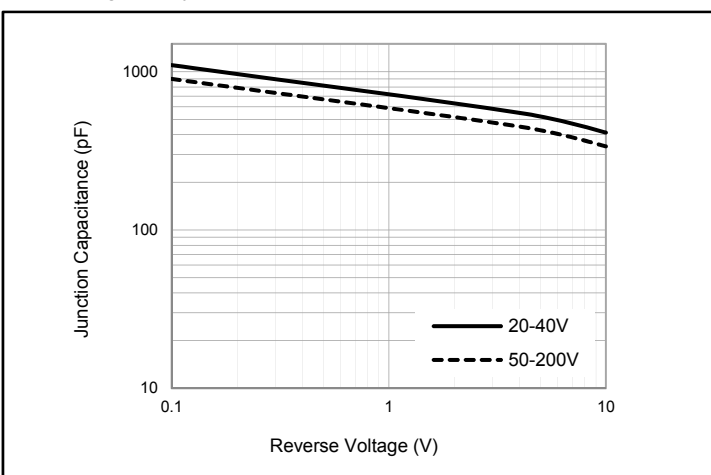
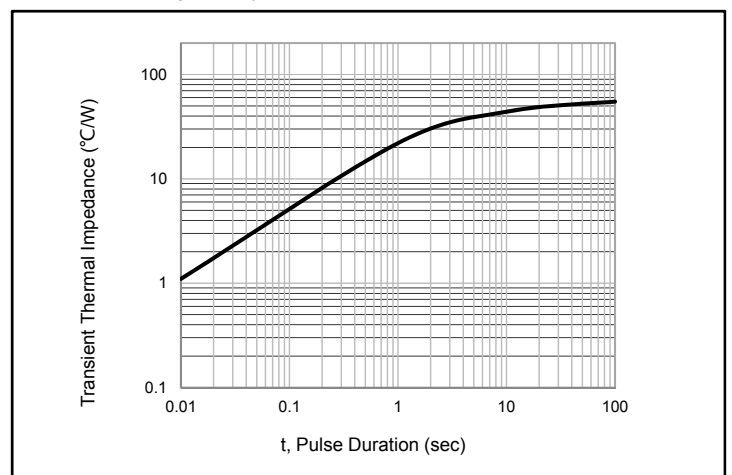
Note1: 8.3ms single half sine-wave superimposed on rated load

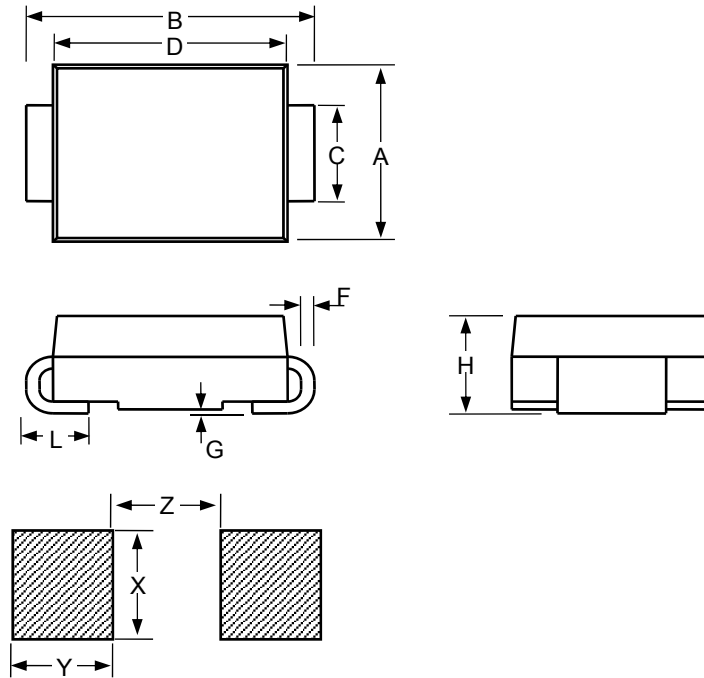
Note2: Measured at 1MHz and applied reverse voltage of 4.0V DC.

Note3: PCB. mounted with 16×16mm copper pad areas

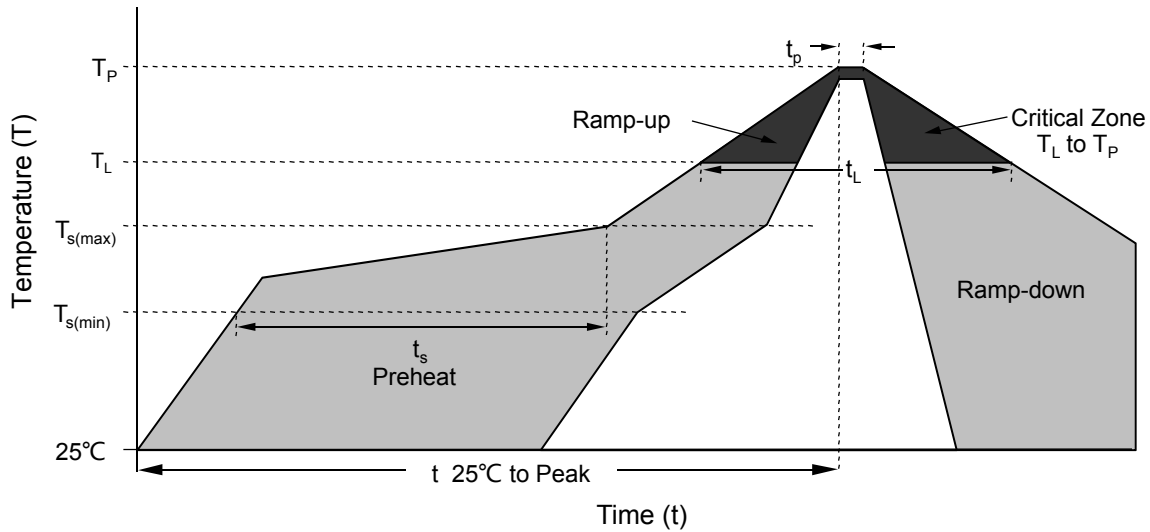
Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
SMC	Tape/Reel, 13" reel	3000	EIA-481-1
	Tape/Reel, 7" reel	500	EIA-481-1

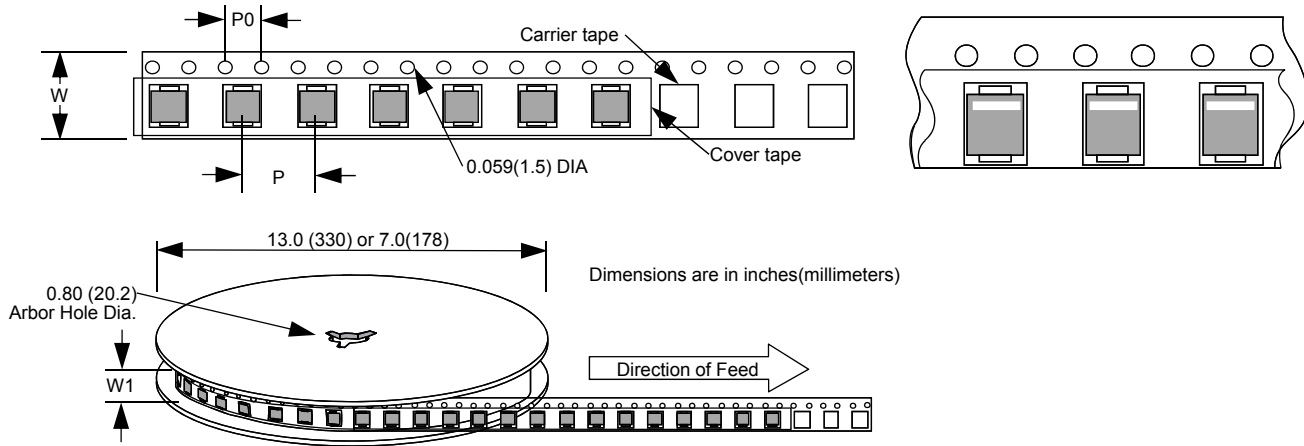

Fig. 1 - Forward Current Derating Curve

Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

Fig. 3 - Typical Instantaneous Forward Characteristics

Fig. 4 - Typical Reverse Characteristics

Fig. 5 - Typical Junction Capacitance

Fig. 6 - Typical Transient Thermal Impedance



SMC						
Dimension	Inches			Millimeters		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.22		0.245	5.59		6.22
B	0.305		0.32	7.75		8.13
C	0.114		0.126	2.9		3.2
D	0.26		0.28	6.6		7.11
L	0.03		0.06	0.76		1.52
F	0.006		0.012	0.15		0.305
G	-		0.008	-		0.203
H	0.087		0.11	2.2		2.8
X		0.15			3.82	
Y		0.119			3.03	
Z		0.151			3.84	



Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Time (t_L)	60 – 150 secs
Peak Temperature (T_P)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 secs
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (t)		8 minutes Max.
Do not exceed		260°C



Dimension	Inches			Millimeters		
	MIN	NOM	MAX	MIN	NOM	MAX
P		0.315			8	
P0		0.157			4	
W		0.63			16	
W1		0.646			16.4	

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